



PATENT
8013-1147

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Hirokazu HONDA

Conf. 7187

Application No. 09/678,609

Group 2827

Filed October 4, 2000

Examiner D. Graybill

MULTILAYER INTERCONNECTION BOARD, SEMICONDUCTOR DEVICE HAVING THE SAME, AND METHOD OF FORMING THE SAME AS WELL AS METHOD OF MOUNTING THE SEMICONDUCTOR CHIP ON THE INTERCONNECTION BOARD

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

September 15, 2004

Sir:

In compliance with Rules 1.97 and 1.98, and in fulfillment of the duty of disclosure under Rule 1.56, the accompanying document, a copy of which is attached to this statement, is made of record on the enclosed Form PTO-1449.

A concise explanation of the relevance of this item is that this reference was cited by the Japanese Patent Office in the corresponding Japan Application Serial No. 2000-057767, filed March 2, 2000. A copy of the Japanese Official Action in which it was cited is attached hereto, with what is believed to be the pertinent portion enclosed in a wavy line. **An English translation of the enclosed portion is also attached hereto.**

Under the provisions of 37 CFR 1.97(e), the undersigned hereby certifies that each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign Patent Office in a counterpart foreign application not more than three months prior to the filing of this Statement.

Respectfully submitted,

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September 15, 2004

FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO.: 8013-1147	SERIAL NO. 09/678,609
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary)		APPLICANT Hirokazu HONDA	
.98(b)		FILING DATE October 4, 2000	GROUP 2827

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		PATENT NUMBER	ISSUE DATE	PATENTEE	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						

FOREIGN PATENT OR PUBLISHED FOREIGN PATENT APPLICATION

		DOCUMENT NO.	PUBL. DATE	COUNTRY OR PATENT OFFICE	CLASS	SUB CLASS	TRANSLATION YES NO
	AI	10-125818	05/98	Japan			
	AJ						
	AK						
	AL						
	AM						
	AN						
	AO						
	AP						
	AQ						

OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

AT	
AU	
AV	
AX	
AY	

EXAMINER**DATE CONSIDERED**

EXAMINER: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.